



Product/Process Change Notice - PCN 09_0129 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of receiving this notification. The information contained within this PCN is considered proprietary and should not be shared outside of your company. ADI contact information is listed below.

PCN Title: ADA4505-2 Fab transfer to TSMC, Taiwan
Publication Date: 06-Jul-2009
Samples Available Date: 24-Jun-2009
Effectivity Date: 30-Sep-2009 *(the earliest date that a customer could expect to receive changed material)*

Description Of Change

From: Wafer fab on 0.6um CMOS process at Analog Devices, Limerick, Ireland.
To: Wafer fab on 0.6um CMOS process at TSMC, Taiwan.
ADA4505-2 data sheet specifications will not change as a result of this transfer.

Reason For Change

Increased wafer fabrication capacity.

Impact of the change (positive or negative) on fit, form, function & reliability

There will be no impact on the form, fit, function, quality or reliability of the ADA4505-2 devices.

Summary of Supporting Information

Qualification is in process as per Analog Devices specification ADI0012, Procedure for Qualification of New or Revised Processes or Products. See attached qualification data.

Supporting Documents

Attachment 1: ADI_PCN_09_0129_Rev_-_ada4505-2 Qual Data.doc

For questions on this PCN, send email to the regional contacts below or contact your local ADI sales representative

Americas: PCN_Americas@analog.com

Europe: PCN_Europe@analog.com

Japan: PCN_Japan@analog.com

Rest of Asia: PCN_ROA@analog.com

Appendix A - Affected ADI Models			
Added Parts On This Revision - Product Family / Model Number (4)			
ADA4505-2 / ADA4505-2ACBZ-R7	ADA4505-2 / ADA4505-2ACBZ-RL	ADA4505-2 / ADA4505-2ARMZ	ADA4505-2 / ADA4505-2ARMZ-RL

Appendix B - Revision History		
Rev	Publish Date	Rev Description
Rev. -	06-Jul-2009	Initial Release